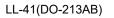
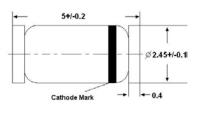


## Silicon Planar Power Zener Diodes

For use in stabilizing and clipping circuits with high power rating. Standard Zener voltage tolerance is ±10%.





Glass case MELF Dimensions in mm

# Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	1 <sup>1)</sup>	W
Operating Junction Temperature	Tj	175	°C
Storage Temperature Range	T <sub>stg</sub>	- 65 to + 175	°C

<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature.

### **Thermal Characteristics**

Parameter	Symbol	Max.	Unit	
Thermal Resistance Junction to Ambient	$R_{ extsf{ heta}JA}$	170 <sup>1)</sup>	°C/W	
Forward Voltage at I <sub>F</sub> = 200 mA	V <sub>F</sub>	1.2	V	

<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature.

#### Characteristics at T<sub>a</sub> = 25°C

Туре	Zener Voltage <sup>3)</sup>			Dynamic Resistance <sup>1)</sup>			Reverse Current			Maximum Regulator	
	Vz	@Izt ('	V)	at $I_{\text{ZT}}$	$Z_{\text{ZT}}$ at $I_{\text{ZT}}$	Z <sub>ZK</sub>	at I <sub>ZK</sub>	I <sub>R</sub> (μA)	at $V_{\text{R}}$	at T <sub>a</sub> = 25℃	Current <sup>2</sup>
	Nom	Min.	Max.	(mA)	Max. (Ω)	Max. (Ω)	(mA)	Max.	(V)	I <sub>ZSM</sub> (mA)	I <sub>ZM</sub> (mA)
ZM4734A-GS08	5.6	5.04	6.16	45	5	600	1	10	2	810	162

<sup>1)</sup> The dynamic resistance is derived from the 60 Hz AC voltage which results when an AC current having an RMS value equal to 10% of the Zener Current (I<sub>ZT</sub> or I<sub>ZK</sub>) is superimposed on I<sub>ZT</sub> or I<sub>ZK</sub>. Dynamic resistance is measured at two points to insure a sharp knee on the breakdown curve and to eliminate unstable units.

<sup>2)</sup> Valid provided that electrodes are kept at ambient temperature.

 $^{3)}$  Tested with pulses tp = 20 ms.

<sup>4)</sup> The rating listed in the electrical characteristics table is maximum peak, non-repetitive, reverse surge current of 1/2 square wave or equivalent sine wave pulse of 1/120 second duration superimposed on the test current I<sub>ZT</sub>.



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